

Product data sheet

1. General description

Planar passivated sensitive gate four quadrant triac in a TO92 plastic package intended for use in applications requiring enhanced noise immunity and direct interfacing to logic ICs and low power gate drivers.

2. Features and benefits

- Direct interfacing to logic level ICs
- Enhanced current surge capability
- Enhanced noise immunity
- High blocking voltage of 600V
- · Planar passivated for voltage ruggedness and reliability
- Sensitive gate in four quadrants
- Triggering in all four quadrants

3. Applications

- General purpose low power motor control
- Home appliances
- Industrial process control
- Low power AC Fan controllers

4. Quick reference data

uick reference data						
Parameter	Conditions		Min	Тур	Max	Unit
maximum rating						
repetitive peak off-state voltage			-	-	600	V
RMS on-state current	full sine wave; T _{lead} ≤ 45 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>		-	-	1	A
non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u>		-	-	12.5	А
	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms		-	-	13.8	А
junction temperature			-	-	125	°C
Parameter	Conditions		Min	Тур	Max	Unit
aracteristics		· · · ·				
gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>		0.4	-	10	mA
	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; <u>Fig. 7</u>		0.4	-	10	mA
	V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u>		0.4	-	10	mA
	V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 7</u>		0.4	-	10	mA
holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	10	mA
on-state voltage	I _T = 1 A; T _i = 25 °C; <u>Fig. 10</u>		-	1.3	1.6	V
	Parameter maximum rating repetitive peak off-state voltage RMS on-state current non-repetitive peak on-state current junction temperature Parameter aracteristics gate trigger current holding current	ParameterConditionsmaximum ratingrepetitive peak off-state voltagefull sine wave; $T_{iead} \le 45 \text{ °C}$; Fig. 1; Fig. 2; Fig. 3RMS on-state currentfull sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 20 \text{ ms}$; Fig. 4; Fig. 5non-repetitive peak on- state currentfull sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 16.7 \text{ ms}$ junction temperaturerull sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 16.7 \text{ ms}$ ParameterConditionsaracteristics $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G} + ;$ $T_j = 25 \text{ °C}; Fig. 7$ $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G} + ;$ $T_j = 25 \text{ °C}; Fig. 7$ $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2+ G} - ;$ $T_j = 25 \text{ °C}; Fig. 7$ $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G} - ;$ $T_j = 25 \text{ °C}; Fig. 7$ $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G} - ;$ $T_j = 25 \text{ °C}; Fig. 7$ $V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T2- G} + ;$ $T_j = 25 \text{ °C}; Fig. 7$ holding current $V_D = 12 \text{ V}; \text{ T}_j = 25 \text{ °C}; Fig. 9$	ParameterConditionsmaximum ratingrepetitive peak off-state voltageRMS on-state currentfull sine wave; $T_{lead} \le 45 \ ^{\circ}C$; Fig. 1; Fig. 2; Fig. 3non-repetitive peak on- state currentfull sine wave; $T_{j(nit)} = 25 \ ^{\circ}C$; $t_p = 20 \ ms$; Fig. 4; Fig. 5junction temperaturefull sine wave; $T_{j(nit)} = 25 \ ^{\circ}C$; $t_p = 16.7 \ ms$ ParameterConditionsgate trigger current $V_D = 12 \ V$; $I_T = 0.1 \ A$; $T2+ \ G+$; $T_j = 25 \ ^{\circ}C$; $Fig. \ Z$ gate trigger current $V_D = 12 \ V$; $I_T = 0.1 \ A$; $T2+ \ G-$; $T_j = 25 \ ^{\circ}C$; $Fig. \ Z$ $V_D = 12 \ V$; $I_T = 0.1 \ A$; $T2- \ G-$; $T_j = 25 \ ^{\circ}C$; $Fig. \ Z$ holding current $V_D = 12 \ V$; $I_T = 0.1 \ A$; $T2- \ G+$; $T_j = 25 \ ^{\circ}C$; $Fig. \ Z$	ParameterConditionsMinmaximum rating	ParameterConditionsMinTypmaximum ratingrepetitive peak off-state voltageRMS on-state currentfull sine wave; $T_{lead} \le 45 ^{\circ}C$; Fig. 1; Fig. 2; Fig. 3non-repetitive peak on- state currentfull sine wave; $T_{light} = 25 ^{\circ}C$; $t_p = 20 \text{ms}$; Fig. 4; Fig. 5junction temperaturefull sine wave; $T_{lj(nit)} = 25 ^{\circ}C$; $t_p = 16.7 \text{ms}$ parameterConditionsMinTyparacteristicsV_p = 12 V; $I_T = 0.1 \text{A}$; T2+ G+; $T_j = 25 ^{\circ}C$; Fig. 70.4-gate trigger current $V_p = 12 V; I_T = 0.1 \text{A}; T2+ G-;$ $T_j = 25 ^{\circ}C; Fig. 70.4-V_p = 12 V; I_T = 0.1 \text{A}; T2- G-;T_j = 25 ^{\circ}C; Fig. 70.4-V_p = 12 V; I_T = 0.1 \text{A}; T2- G+;T_j = 25 ^{\circ}C; Fig. 70.4-holding currentV_p = 12 V; I_T = 25 ^{\circ}C; Fig. 9$	Parameter Conditions Min Typ Max maximum rating repetitive peak off-state voltage - - 600 RMS on-state current voltage full sine wave; $T_{iead} \le 45 ^{\circ}$ C; $F_{ig.,1}$; $Fig.,2$; $Fig.,3$ - - 1 non-repetitive peak on-state current full sine wave; $T_{i(mit)} = 25 ^{\circ}$ C; $t_p = 20 \text{ms}$; $Fig.,4$; $Fig.,5$ - - 12.5 full sine wave; $T_{i(mit)} = 25 ^{\circ}$ C; $t_p = 16.7 \text{ms}$ - - 13.8 junction temperature conditions - - 125 Parameter Conditions Min Typ Max aracteristics $y_D = 12 ^{\circ}$; $I_T = 0.1 ^{\circ}$; $T2 + G+;$ 0.4 - 10 $V_D = 12 ^{\circ}$; $I_T = 0.1 ^{\circ}$; $T2 + G-;$ 0.4 - 10 10 $V_D = 12 ^{\circ}$; $I_T = 0.1 ^{\circ}$; $T2 - G-;$ 0.4 - 10 10 $V_D = 12 ^{\circ}$; $I_T = 0.1 ^{\circ}$; $T2 - G-;$ 0.4 - 10 10 10 10 10 10 10 10 10 10 10 10

Z0109MA0

4Q Triac

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Dynamic characteristics							
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 110 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit; Fig. 12		120	-	-	V/µs
dV _{com} /dt	rate of change of commutating voltage	V_{D} = 400 V; T _j = 110 °C; dI _{com} /dt = 0.44 A/ms; gate open circuit		2	-	-	V/µs

5. Pinning information

Table 2. P	Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol					
1	T2	main terminal 2		Ν					
2	G	gate	Litter and the second sec						
3	T1	main terminal 1) TO-92 (SOT54)	sym051					

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
Z0109MA0	TO92	Z0109MA0,412	Bulk	1000	SOT54	14-Nov-2013		

7. Marking

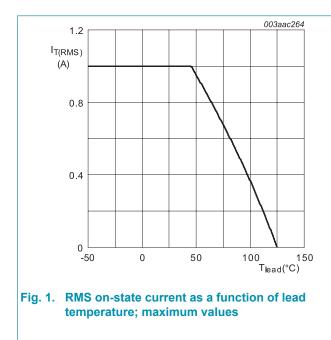
Table 4. Marking codes						
	Type number	Marking codes				
	Z0109MA	109MA0				

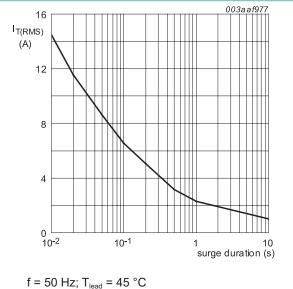
8. Limiting values

Table 5. Limiting values

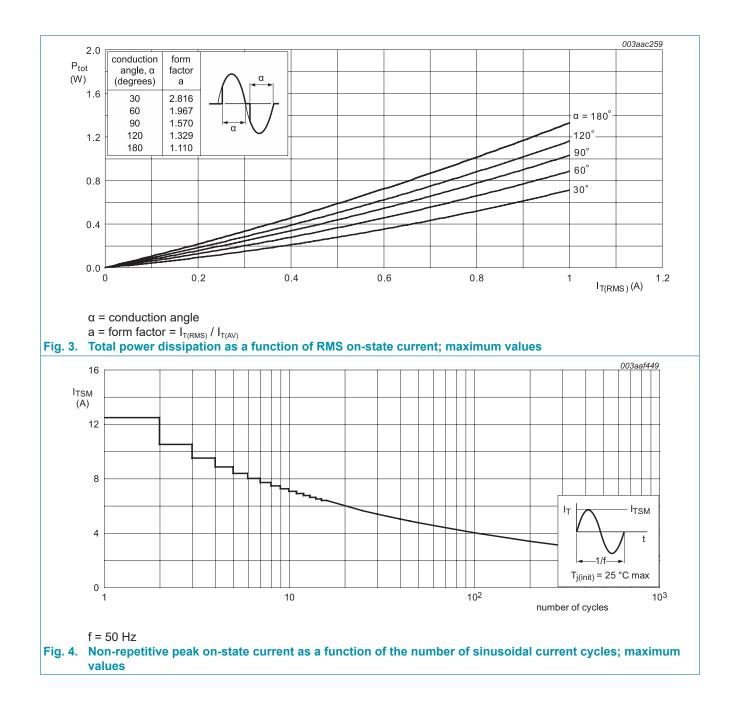
In accordance with the Absolute Maximum Rating System (IEC 60134).

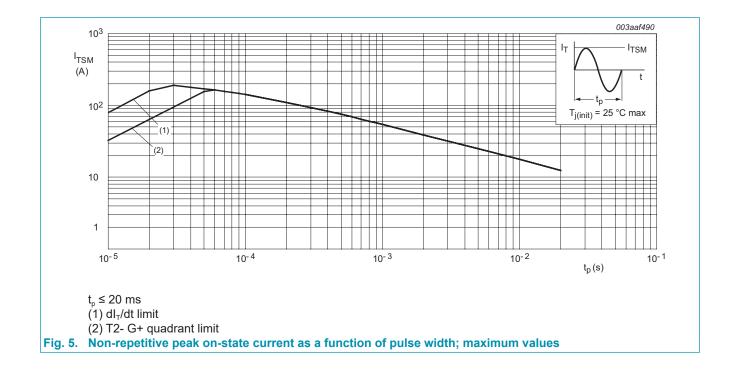
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 45 °C; <u>Fig. 1; Fig. 2</u> ; <u>Fig. 3</u>	-	1	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; Fig. 4; Fig. 5	-	12.5	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	13.8	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	0.78	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 20 mA; T2+ G+	-	50	A/µs
		I _G = 20 mA; T2+ G-	-	50	A/µs
		I _G = 20 mA; T2- G-	-	50	A/µs
		I _G = 20 mA; T2- G+	-	20	A/µs
I _{GM}	peak gate current		-	1	А
P _{GM}	peak gate power		-	2	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
T _i	junction temperature		-	125	°C





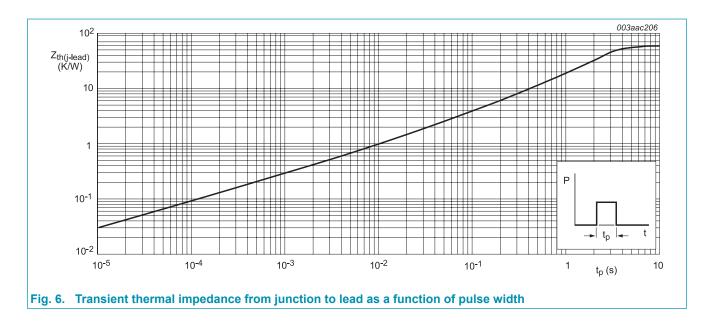






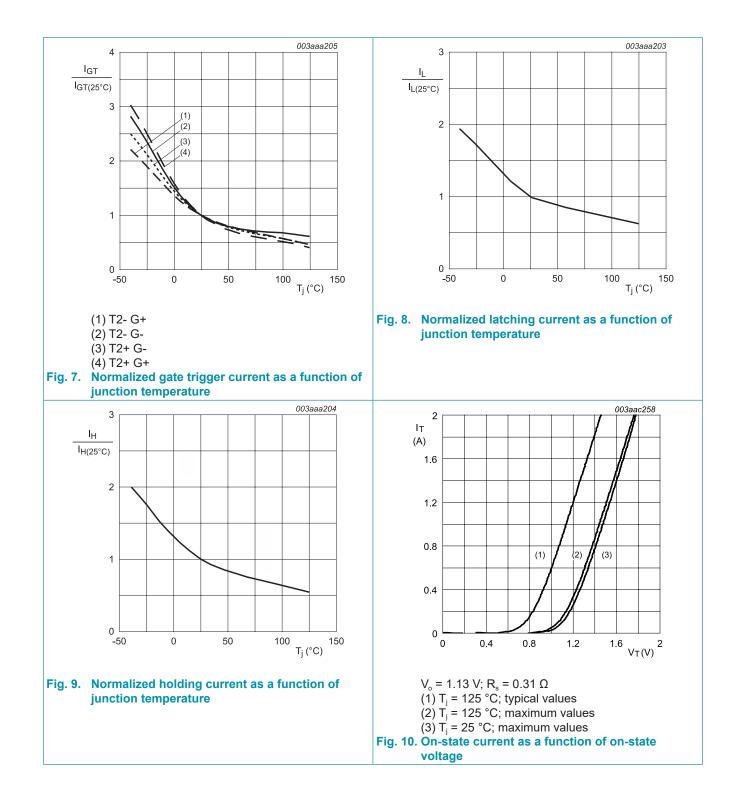
9. Thermal characteristics

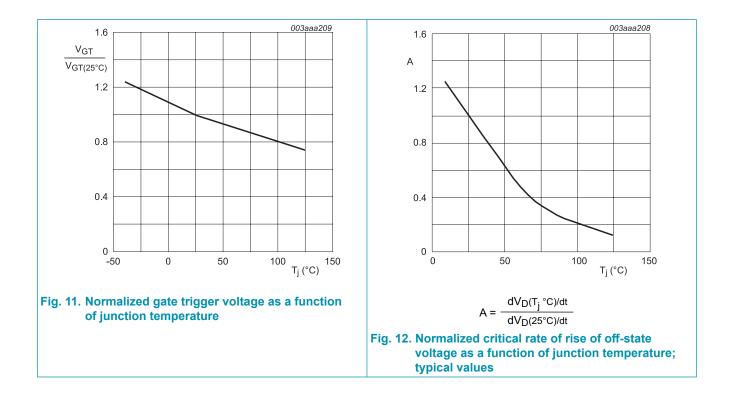
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	full cycle; <u>Fig. 6</u>	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	full cycle; printed circuit board: lead length = 4 mm	-	150	-	K/W



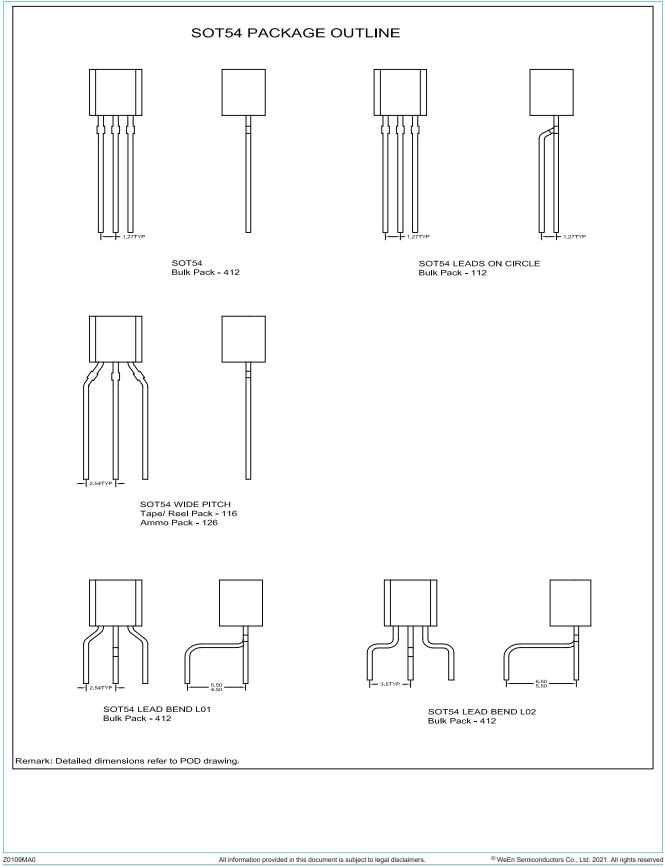
10. Characteristics

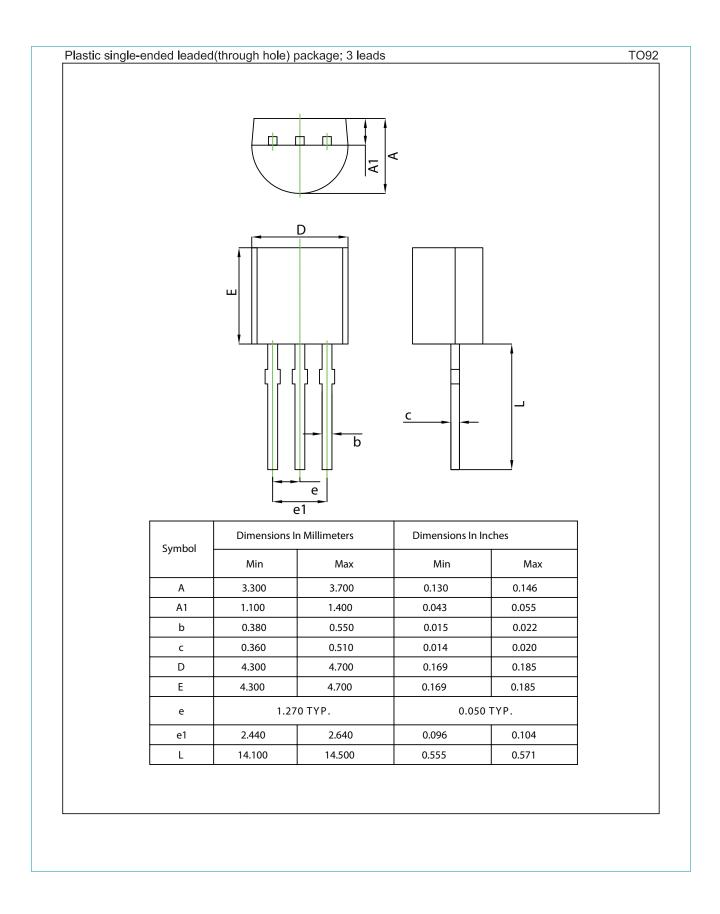
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ T _j = 25 °C; Fig. 7	0.4	-	10	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; Fig. 7	0.4	-	10	mA
		$V_{\rm D}$ = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; Fig. 7	0.4	-	10	mA
		$V_{\rm D}$ = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; Fig. 7	0.4	-	10	mA
IL	latching current	V_{D} = 12 V; I _G = 0.1 A; T2+ G+; T _j = 25 °C; Fig. 8	-	-	15	mA
		$V_{\rm D}$ = 12 V; I _G = 0.1 A; T2+ G-; T _j = 25 °C; Fig. 8	-	-	30	mA
		V _D = 12 V; I _G = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	15	mA
		$V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T2- G+};$ T _j = 25 °C; Fig. 8	-	-	15	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V _T	on-state voltage	$I_{T} = 1 \text{ A}; T_{j} = 25 \text{ °C}; Fig. 10$	-	1.3	1.6	V
V _{gt}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11	-	-	1	V
		V _D = 600 V; I _T = 0.1 A; T _j = 125 °C	0.2	-	-	V
I _D	off-state current	V _D = 600 V; T _j = 125 °C	-	-	0.5	mA
Dynamic	characteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 110 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit; Fig. 12	120	-	-	V/µs
dV _{com} /dt	rate of change of commutating voltage	V_D = 400 V; T _j = 110 °C; dI _{com} /dt = 0.44 A/ms; gate open circuit	2	-	-	V/µs





11. Package outline





12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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